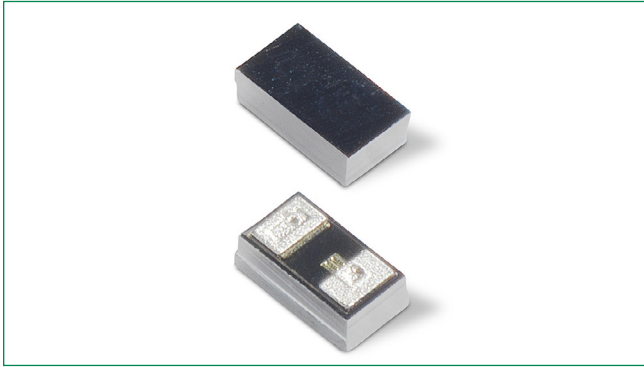


SP3145 Series 0.35pF 20kV Unidirectional Discrete TVS



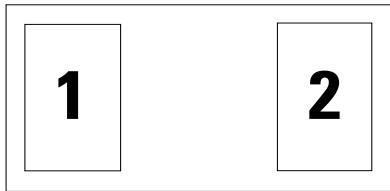
OBSOLETE DATE: 06/10th/2020 PCN/ECN#_ESU270-51
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Description

The SP3145 represents an industry first: unidirectional ESD protection in a 01005 type package. Unidirectional protection should be favored over bi directional performance, particularly on logic and data lines, which typically do not transit zero volts during standard operation. Fast-acting, semiconductor based technology can withstand multiple ESD events, without wear-out or degradation. Low nominal capacitance makes this product meaningful for interfaces running at high data rates, approaching 5 GHz clock speeds.

Pinout

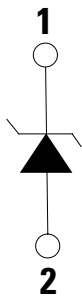


Note: Drawing not to scale

Features

- ESD, IEC 61000-4-2, ±20kV contact, ±25kV air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Lightning, IEC 61000-4-5 2nd edition, 1A (tP=8/20µs)
- Low capacitance of 0.35pF (@ VR=0V)
- Low leakage current of 20nA (MAX) at 2.8V
- Industry-first unidirectional protection, critical for data line protection, and any interface which does not transit zero volts
- Industry's smallest single channel form factor, nominally 01005
- Halogen free, Lead free and RoHS compliant

Functional Block Diagram



Applications

- Mobile Phones
- Smart Phones
- Camcorders
- Portable Medical
- Digital Cameras
- Wearable Technology
- Portable Navigation Components
- Tablets
- Point of Sale Terminals

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
I_{PP}	Peak Current ($t_p=8/20\mu s$)	1.0 ¹	A
T_{OP}	Operating Temperature	-40 to 125	°C
T_{STOR}	Storage Temperature	-55 to 150	°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

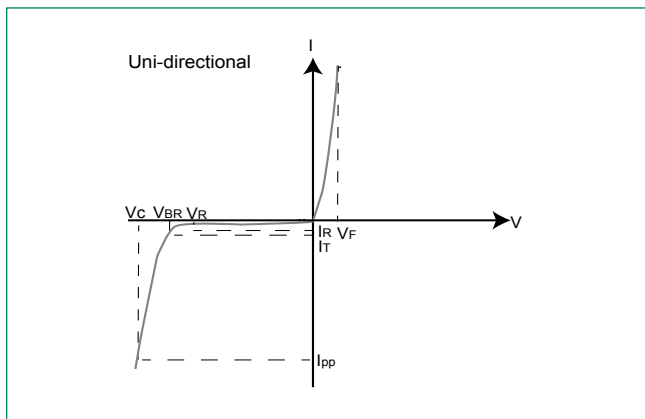
Electrical Characteristics ($T_{OP}=25^\circ C$)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Reverse Standoff Voltage	V_{RWM}	-	-	-	3.3	V
Breakdown Voltage	V_{BR}	$I_R=1mA$	-	7.5	-	V
Forward Voltage	V_F	$I_T=1mA$	0.5	0.7	1.0	V
Leakage Current ¹	I_{LEAK}	$V_R=1.5V$ with 1 pin at GND	-	<1	5	nA
		$V_R=2.8V$ with 1 pin at GND	-	2.0	20	
Clamp Voltage ¹	V_C	$I_{PP}=1A, t_p=8/20\mu s, Fwd$	-	11.5	-	V
Dynamic Resistance ²	R_{DYN}	TLP, $t_p=100ns, I/O$ to GND	-	3.5	-	Ω
ESD Withstand Voltage ¹	V_{ESD}	IEC 61000-4-2 (Contact Discharge)	± 20	-	-	kV
		IEC 61000-4-2 (Air Discharge)	± 25	-	-	kV
Diode Capacitance ¹	C_D	Reverse Bias=0V	-	0.35	-	pF

Note:

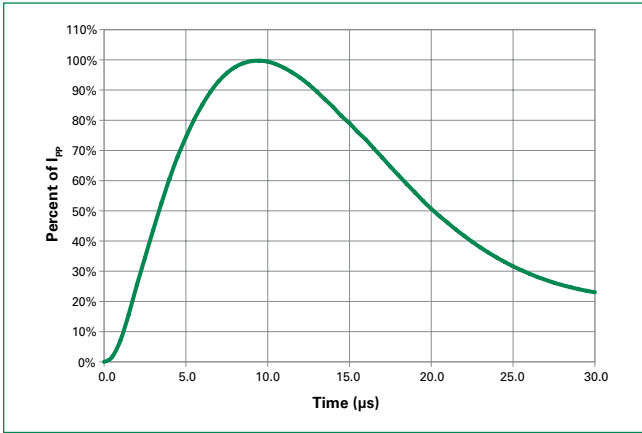
- Parameter is guaranteed by design and/or component characterization.
- Transmission Line Pulse (TLP) with 100ns width, 2ns rise time, and average window $t_1=70ns$ to $t_2=90ns$

I-V Curve Characteristics

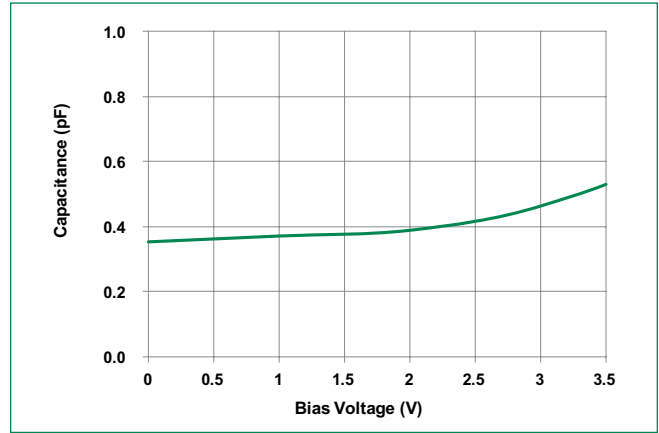


- V_R Stand-off Voltage** – Maximum voltage that can be applied to the TVS without operation
- V_{BR} Breakdown Voltage** – Maximum voltage that flows through the TVS at a specified test current (I_T)
- V_C Clamping Voltage** – Peak voltage measured across the TVS at a specified I_{ppm} (peak impulse current)
- I_R Reverse Leakage Current** – Current measured at V_R
- V_F Forward Voltage Drop for Uni-directional**

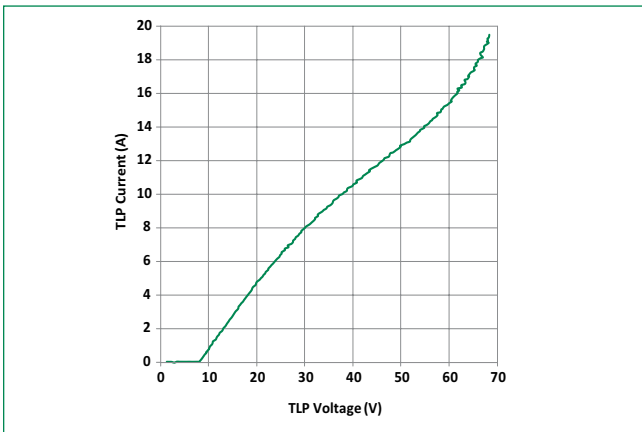
8/20µs Pulse Waveform



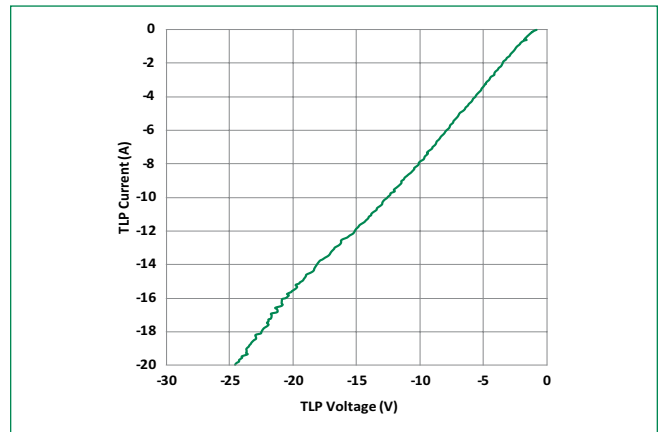
Capacitance vs Reverse Bias



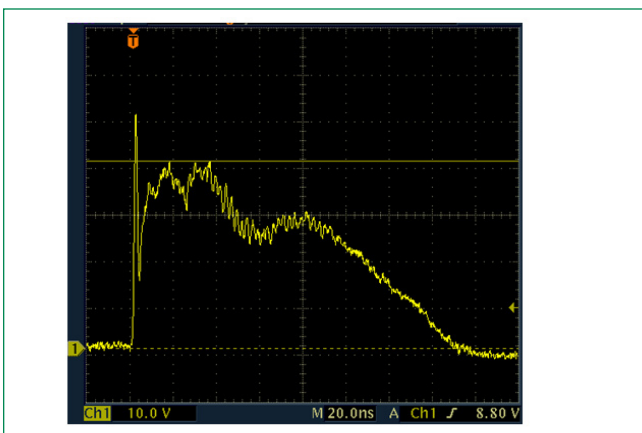
Positive Transmission Line Pulsing (TLP) Plot



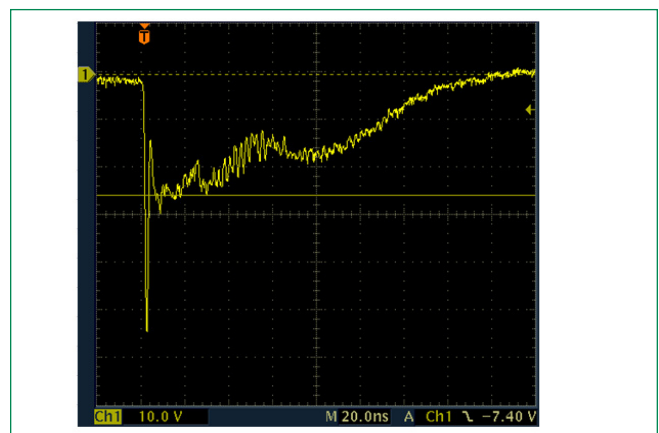
Negative Transmission Line Pulsing (TLP) Plot



IEC 61000-4-2 +8 kV Contact ESD Clamping Voltage

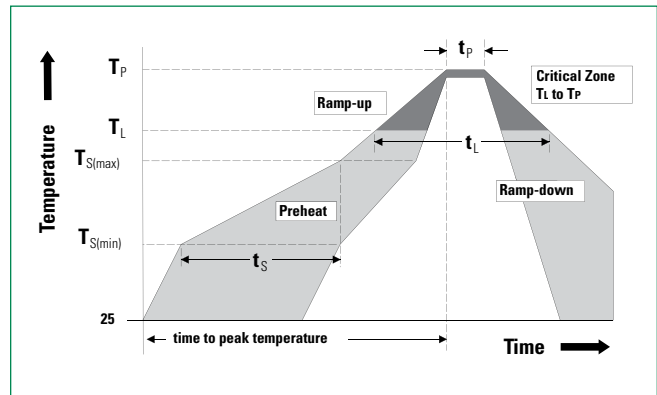


IEC 61000-4-2 -8 kV Contact ESD Clamping Voltage

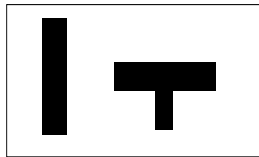


Soldering Parameters

Reflow Condition		Pb - Free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 - 180 secs
Average ramp up rate (Liquidus) Temp (T_L) to peak		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_t)	60 - 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		20 - 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		260°C



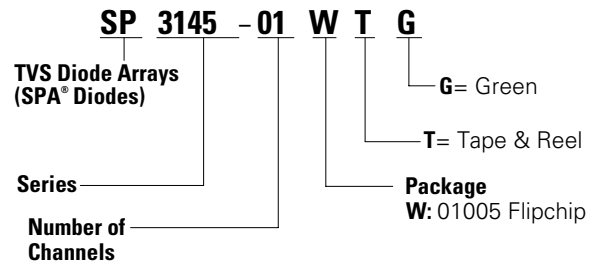
Part Marking System



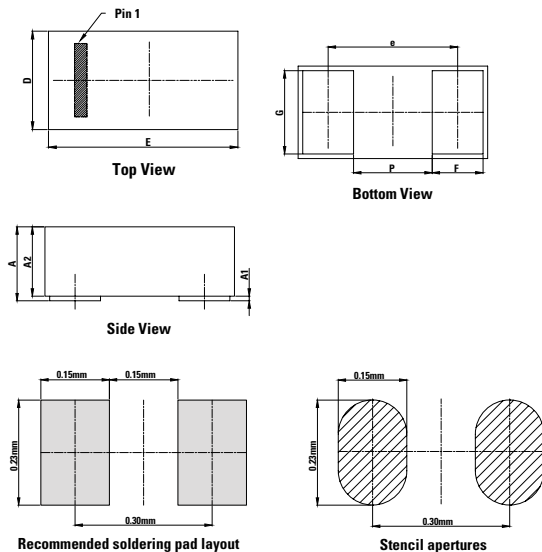
Ordering Information

Part Number	Package	Min. Order Qty.
SP3145-01WTG	01005 Flipchip	15000

Part Numbering System



Package Dimensions — 01005 Flipchip



Symbol	01005 Flipchip					
	Millimeters			Inches		
	Min	Typ	Max	Min	Typ	Max
A	0.168	0.181	0.194	0.007	0.007	0.008
A1	0.008	0.011	0.014	0.000	0.000	0.001
A2	0.160	0.170	0.180	0.006	0.007	0.007
e	0.280 BSC			0.011 BSC		
D	0.200	0.230	0.260	0.008	0.009	0.010
E	0.400	0.430	0.460	0.016	0.017	0.018
F	0.110	0.130	0.150	0.004	0.005	0.006
G	0.180	0.200	0.220	0.007	0.008	0.009
P	0.130	0.150	0.170	0.005	0.006	0.007

Embossed Carrier Tape & Reel Specification – 01005 Flipchip

